



ESP-12K SPECIFICATION Version V1.0 Copyright ©2019



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Formulation / Revision / Abolition of CV

Version	Date	Formulation / Revision	Make	Verify
V1.0	2020.04.10	First formulated	Yiji Xie	



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1.PRODUCT DESCRIPTION

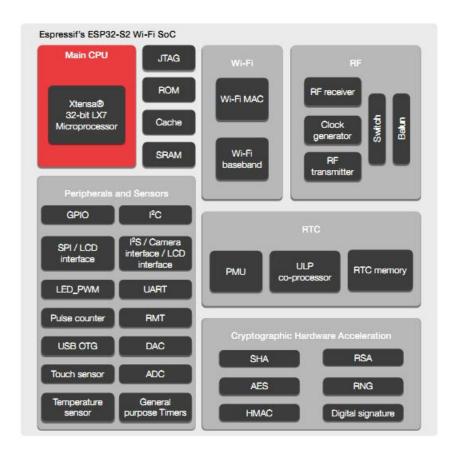
ESP-12K is a Wi-Fi module developed by Ensink Technology. The core processor ESP32-S2 of this module is a highly integrated low-power Wi-Fi system-on-chip (SoC) designed for the Internet of Things (IoT), Mobile devices, wearable electronic devices, smart home and other applications. ESP32-S2 has industry-leading low-power performance and RF performance, supports IEEE802.11b / g / n protocol, integrates Wi-Fi MAC, Wi-Fi RF and baseband, RF switch, RF Balun, power amplifier, low noise Amplifier, etc.

The ESP32-S2 chip is equipped with Xtensa® 32-bit LX7 single-core processor, and its operating frequency is up to 240 MHz. The chip supports secondary development without the use of other microcontrollers or processors. The chip has 320 KB SRAM and 128 KB ROM, and can be connected to flash and RAM through SPI / QSPI / OSPI and other interfaces. ESP32-S2 supports a variety of low-power operating states to meet the power consumption requirements of various application scenarios. The unique fine clock gating function, dynamic voltage clock frequency adjustment function, and RF output power adjustable function of the chip can achieve the best balance between communication distance, communication rate and power consumption.

ESP32-S2 provides a wealth of peripheral interfaces, including SPI, I2S, UART, I2C, LED PWM, LCD interface, Camera interface, ADC, DAC, touch sensor, temperature sensor and up to 43 GPIO.It supports the expansion of PSRAM on the periphery of the chip, and the ESP-12K module can be equipped with PSRAM. In addition, it includes a full-speed USB On-The-Go (OTG) interface that can support the use of USB communication.

ESP32-S2 has a variety of unique hardware security mechanisms. The hardware encryption accelerator supports AES, SHA, and RSA algorithms. The RNG, HMAC and Digital Signature (Digital Signature) modules provide more security features. Other security features include flash encryption and secure boot (se-cure boot) signature verification. The perfect security mechanism enables the chip to be perfectly applied to various encryption products.





Features

- Complete 802.11b / g / n Wi-Fi SoC module, data rate up to 150Mbps
- Built-in ESP32-S2 chip, Xtensa® single-core 32-bit LX7 microprocessor, support up to 240 MHz clock frequency, with 128KB ROM, 320KB SRAM, 16KB RTC SRAM
- Support UART / GPIO / ADC / PWM / SPI / I2C / LCD / I2S / Camera / IR / USB /
 DAC interface, support touch sensor, temperature sensor, pulse counter
- SMD-42 packaging
- Integrate Wi-Fi MAC/ BB/RF/PA/LNA
- Support multiple sleep modes, deep sleep current is less than10uA
- Serial port speed up to4Mbps



- Built-in Lwip protocol stack
- Support STA/AP/STA+AP work mode
- Smart Config (APP) / AirKiss (WeChat) one-click distribution network supporting
 Android and IOS
- Support serial local upgrade and remote firmware upgrade (FOTA)
- General AT command can be used quickly
- Support secondary development, integrated Windows, Linux development environment
- About PSRAM:

ESP-12K supports optional PSRAM, the default 2 kinds of PSRAM configuration, the shield can be distinguished on the silk screen. For details, please refer to the product appearance drawing.

ESP-12K(00) without PSRAM

ESP-12K(08) configuration 8MByte PSRAM

Main parameter

List 1 Main parameter

Model Name	ESP-12K	
Packaging	SMD-42	
Size	31.0*18.0*3.0(±0.2)MM	
Antenna	PCB antenna/IPEX connector	
Spectrum range	2400 ~ 2483.5MHz	
Work Temperature	-40 ℃ ~ 85 ℃	
Storage environment	-40 °C ~ 125 °C , < 90%RH	
Power Supply Range	Voltage 3.0V ~ 3.6V, Current >500mA	



Interface UART/GPIO/ADC/PWM/SPI/I2C/LCD/I2S/Camera/IR/US C	
IO port qty	37
Serial rate	Support 110 ~ 4608000 bps ,default 115200 bps
Safety	WEP/WPA-PSK/WPA2-PSK
SPI Flash	Default 32Mbit
PSRAM	Optional without PSRAM or 8MByte PSRAM



2.ELECTRICAL PARAMETER

Parameter		Condition	Min	Typical	Max	Unit
Voltage		VDD	3.0	3.3	3.6	V
	V _{IL} /V _{IH}	-	-0.3/0.75VIO	-	0.25VIO/3.6	V
I/O	V _{OL} /V _{OH}	-	N/0.8VIO	-	0.1VIO/N	V
	I _{MAX}	-	-	-	12	mA

RF performance

Description	Typical	Unit
Work frequency	2400 - 2483.5	MHz
	Output power	
In 11n mode HT40, PA output power is	12±2	dBm
In 11n mode HT20, PA output power is	13±2	dBm
In 11g mode, PA output power is	14±2	dBm
In 11b mode, PA output power is	16±2	dBm
Re	ceive sensitivity	
CCK, 1 Mbps	<=-96	dBm
CCK, 11 Mbps	<=-88	dBm
6 Mbps (1/2 BPSK)	<=-91	dBm
54 Mbps (3/4 64-QAM)	<=-74	dBm
HT20 (MCS7)	<=-71	dBm
HT40 (MCS7)	<=-68	dBm



Power consumption

The following power consumption data is based on a 3.3V power supply, an ambient temperature of 25 ° C, and is measured using an internal voltage regulator.

- All measurements are done at the antenna interface without SAW filters.
- All transmission data is based on a 90% duty cycle, measured in continuous transmission mode.

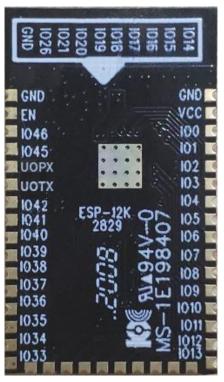
Mode	Mix	Typical	Max	Unit
Send 802.11b, CCK 11Mbps, POUT=+17dBm	-	190	-	mA
Send 802.11g, OFDM 54Mbps, POUT =+15dBm	-	145	-	mA
Send 802.11n, MCS7, POUT =+13dBm	-	120	-	mA
Receive 802.11b,package length 1024bit, -80dBm	-	63	-	mA
Receive 802.11g, package length 1024, -70dBm	-	63	-	mA
Receive 802.11n,package length 1024bit, -65dBm	-	68	-	mA
Modem-Sleep①	-	20	-	mA
Light-Sleep②	-	1.4	-	mA
Deep-Sleep③	-	20	-	μA
Power Off	-	0.5	-	μA



3.DIMENSION

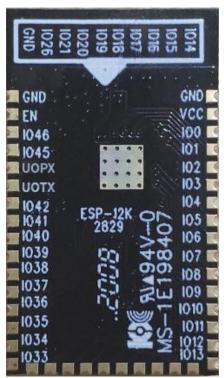
ESP-12K (00)





ESP-12K (08)







4.PIN DEFINITION

The ESP-12K module has a total of 42 interfaces, such as the pin diagram, the pin function definition table is the interface definition



ESP-12K PIN definition diagram

List PIN function definition

No.	item	Function Description
1	GND	ground
2	VCC	Power supply
3	100	RTC_GPIO0, GPIO0
4	IO1	RTC_GPIO1, GPIO1, TOUCH1, ADC1_CH0
5	IO2	RTC_GPIO2, GPIO2, TOUCH2, ADC1_CH1
6	IO3	RTC_GPIO3, GPIO3, TOUCH3, ADC1_CH2
7	104	RTC_GPIO4, GPIO4, TOUCH4, ADC1_CH3
8	IO5	RTC_GPIO5, GPIO5, TOUCH5, ADC1_CH4
9	106	RTC_GPIO6, GPIO6, TOUCH6, ADC1_CH5



10	107	RTC_GPIO7, GPIO7, TOUCH7, ADC1_CH6
11	IO8	RTC_GPIO8, GPIO8, TOUCH8, ADC1_CH7
12	IO9	RTC_GPIO9, GPIO9, TOUCH9, ADC1_CH8, FSPIHD
13	IO10	RTC_GPIO10, GPIO10, TOUCH10, ADC1_CH9, FSPICS0, FSPIIO4
14	IO11	RTC_GPIO11, GPIO11, TOUCH11, ADC2_CH0, FSPID, FSPIIO5
15	IO12	RTC_GPIO12, GPIO12, TOUCH12, ADC2_CH1, FSPICLK, FSPIIO6
16	IO13	RTC_GPIO13, GPIO13, TOUCH13, ADC2_CH2, FSPIQ, FSPIIO7
17	IO14	RTC_GPIO14, GPIO14, TOUCH14, ADC2_CH3, FSPIWP, FSPIDQS
18	IO15	RTC_GPIO15, GPIO15, U0RTS, ADC2_CH4, XTAL_32K_P
19	IO16	RTC_GPIO16, GPIO16, U0CTS, ADC2_CH5, XTAL_32K_N
20	IO17	RTC_GPIO17, GPIO17, U1TXD, ADC2_CH6, DAC_1
21	IO18	RTC_GPIO18, GPIO18, U1RXD, ADC2_CH7, DAC_2, CLK_OUT3
22	IO19	RTC_GPIO19, GPIO19, U1RTS, ADC2_CH8, CLK_OUT2, USB_D-
23	IO20	RTC_GPIO20, GPIO20, U1CTS, ADC2_CH9, CLK_OUT1, USB_D+
24	IO21	RTC_GPIO21, GPIO21
25	IO26	SPICS1, GPIO26
26	GND	接地
27	IO33	SPIIO4, GPIO33, FSPIHD
28	IO34	SPIIO5, GPIO34, FSPICS0
29	IO35	SPIIO6, GPIO35, FSPID
30	IO36	SPIIO7, GPIO36, FSPICLK
31	1037	SPIDQS, GPIO37, FSPIQ
32	IO38	GPIO38, FSPIWP



33	IO39	MTCK, GPIO39, CLK_OUT3
34	IO40	MTDO, GPIO40, CLK_OUT2
35	IO41	MTDI, GPIO41, CLK_OUT1
36	IO42	MTMS, GPIO42
37	U0TX	U0TXD, GPIO43, CLK_OUT1
38	U0RX	U0RXD, GPIO44, CLK_OUT2
39	IO45	GPIO45
40	IO46	GPIO46
41	EN	High level: chip enable; Low level: the chip is off; Has been raised by default.
42	GND	Ground

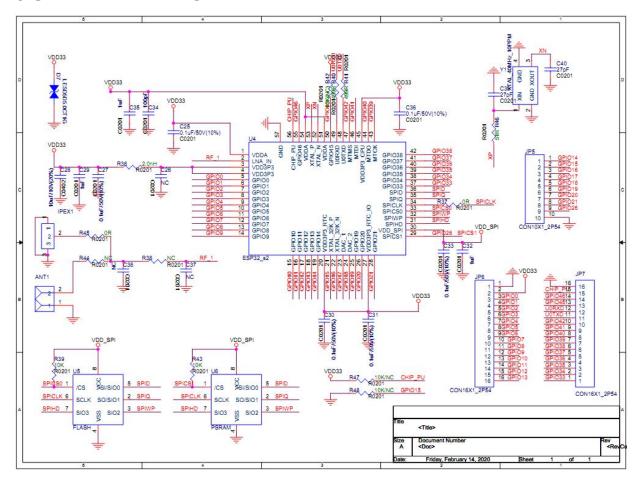
List Module startup mode description

System startup mode						
Pin Default SPI startup mode Download startu						
IO0	Pull up	1	0			
IO46	Pull down	Irrelevant	0			

Note: Some pins have been pulled up internally, please refer to the schematic



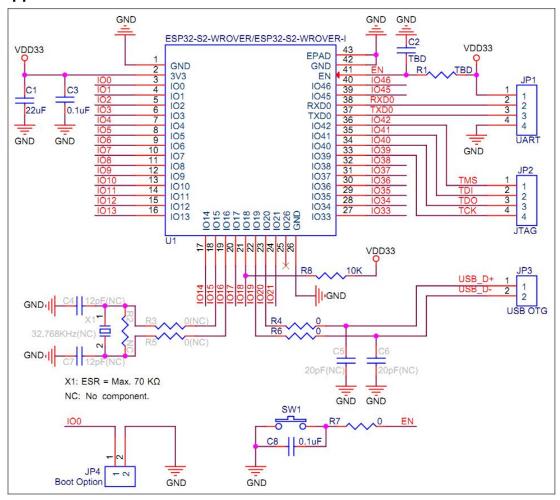
5.SCHEMATIC DIAGRAM





6.DESIGN GUIDE

1. Application circuit

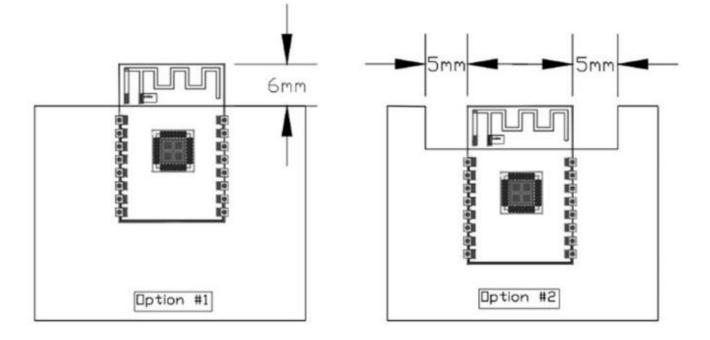


note:

- (1) The RC delay circuit needs to be added to the EN pin. It is recommended that $R = 10k\Omega$ and $C = 0.1\mu F$;
- (2) GPIO18 as U1RXD needs to add a pull-up resistor externally.

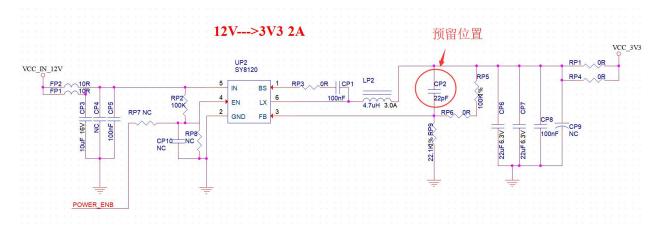
2. Antenna layout requirements

- (1) The following two methods are recommended for the installation location on the motherboard:
- Option 1: Place the module on the edge of the main board, and the antenna area protrudes from the edge of the main board.
- Option 2: Place the module on the edge of the motherboard, and the edge of the motherboard digs out an area at the position of the antenna.
- (2) In order to meet the performance of the onboard antenna, it is forbidden to place metal parts around the antenna, away from high-frequency devices.



3. Power supply

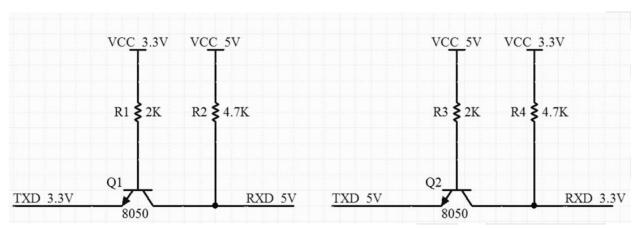
- (1) 3.3V voltage is recommended, the peak current is more than 500mA
- (2) It is recommended to use LDO for power supply; if using DC-DC, it is recommended to control the ripple within 30mV.
- (3) It is recommended to reserve the position of the dynamic response capacitor in the DC-DC power supply circuit, which can optimize the output ripple when the load changes greatly.
- (4), 3.3V power interface is recommended to add ESD devices.



4. Use of GPIO port

- (1) Some GPIO ports are led out of the periphery of the module. If you need to use a 10-100 ohm resistor in series with the IO port. This can suppress overshoot, and the level on both sides is more stable. Helps both EMI and ESD.
- (2) For the up and down of the special IO port, please refer to the instruction manual of the specification, which will affect the startup configuration of the module.
- (3) The IO port of the module is 3.3V. If the IO level of the main control and the module does not match, a level conversion circuit needs to be added.
- (4) If the IO port is directly connected to the peripheral interface, or the pin header and other terminals, it is recommended to reserve ESD devices near the terminal of the IO trace.





Pic Level shift circuit



7.PACKAGING

As shown below, the packaging of ESP-12K is taping.



8.CONTACT US

Website: https://www.ai-thinker.com

Development DOCS: https://docs.ai-thinker.com

Official forum: http://bbs.ai-thinker.com

Sample purchase: https://aithinker.onesite.alibaba.com/

Business: sales@aithinker.com

Technical support: support@aithinker.com

Add: 408-410, Block C, Huafeng Smart Innovation Port, Gushu 2nd Road, Xixiang, Baoan District, Shenzhen

Tel: 0755-29162996



Integration instructions for host product manufacturers according to KDB 996369 D03 OEM Manual v01 2.2 List of applicable FCC rules

The ESP-12K is an Wi-Fi Module with digitally modulated systems using an DSSS with DBPSK/DQPSK/CCK for 802.11b; OFDM with BPSK/QPSK/16QAM/64QAM for 802.11g/n; modulation. It operates on the 2400-2483.5MHz band and, therefore, is within U.S. FCC part 15.247 standard

2.3 Specific operational use conditions

The EUT is a Wi-Fi Module

Operation Frequency: 2412-2462MHz for 802.11b/g/11n(HT20); 2422-2452MHz for 802.11n(HT40);

Modulation Type: DSSS with DBPSK/DQPSK/CCK for 802.11b;

OFDM with BPSK/QPSK/16QAM/64QAM for 802.11g/n;

Number Of Channel: 11 channels for 802.11b/g/11n(HT20); 7 channels for 802.11n(HT40);

Antenna Designation: PCB Antenna

Antenna Gain: 3.0dBi

ESP-12K is a Wi-Fi module developed by Ensink Technology. The core processor ESP32-S2 of this module is a highly integrated low-power Wi-Fi system-on-chip (SoC) designed for the Internet of Things (IoT), Mobile devices, wearable electronic devices, smart home and other applications. ESP32-S2 has industry-leading low-power performance and RF performance, supports IEEE802.11b / g / n protocol, integrates Wi-Fi MAC, Wi-Fi RF and baseband, RF switch, RF Balun, power amplifier, low noise Amplifier, etc.

2.4 Limited module procedures

not applicable; Single Modular Approval Request

2.5 Trace antenna designs

Not applicable;

2.6 RF exposure considerations

To maintain compliance with FCC's RF Exposure guidelines, This equipment should be installed and operated with minimum distance between 20cm the radiator your body: Use only the supplied antenna.

2.7 Antennas

The ESP-12K is an Wi-Fi Module beams signals and communicates with its antenna, which is PCB Antenna. The PCB Antenna gain is 3.0dBi. Antenna could not be in no-load state when module is working. During debugging, it is suggested to add 50 ohms load to the antenna port to avoid damage or performance degradation of the module under long-time no-load condition.

2.8 Label and compliance information

The final end product must be label in a visible area with the following

Host must Contains FCC ID: 2ATPO-ESP-12K. If the size of the end product is larger than 8x10cm, then the following FCC part 15.19 statement has to also be available on the label: This device complies with Part 15 of FCC rules. Operation is subject to the following two conditions:

- (1) this device may not cause harmful interference and
- (2) this device must accept any interference received, including interference that may cause undesired operation.

2.9 Information on test modes and additional testing requirements

Data transfer module demo board can control the EUT work in RF test mode at specified test channel.

2.10 Additional testing, Part 15 Subpart B disclaimer

The module without unintentional-radiator digital circuit, so the module does not required an evaluation by FCC Part 15 Subpart B. The host should be evaluated by the FCC Subpart B.

ATTENTION

This device is intended only for OEM integrators under the following conditions:

- 1) The antenna must be installed such that 20 cm is maintained between the antenna and users, and
- 2) This device and its antenna(s) must not be co located with any other transmitters except in accordance with FCC multi transmitter product procedures. Referring to the multi transmitter policy, multiple transmitter(s) and module(s) can be operated simultaneously without C2P.
- 3) For all products market in US, OEM has to limit the Operating Frequency: 2412-2462MHz by supplied firmware programming tool. OEM shall not supply any tool or info to the end user regarding to Regulatory Domain change.

USERS MANUAL OF THE END PRODUCT:

In the user manual of the end product, the end user has to be informed to keep at least 20cm separation with the antenna while this end product is installed and operated. The end user has to be informed that the FCC radio - frequency exposure guidelines for an uncontrolled environment can be satisfied. The end user has to also be informed that any changes or modifications not expressly approved by the manufacturer could void the user's authority to operate this equipment.

If the size of the end product is smaller than 8x10cm, then additional FCC part 15.19 statement is

required to be available in the users manual: This device complies with Part 15 of FCC rules.

Operation is subject to the following two conditions:

- (1) this device may not cause harmful interference and
- (2) this device must accept any interference received, including interference that may cause undesired operation.

FCC WARNING

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generate, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation.

If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- -- Reorient or relocate the receiving antenna.
- -- Increase the separation between the equipment and receiver.
- -- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- -- Consult the dealer or an experienced radio/TV technician for help.